

DIN-Power Flow032FP-4,5C1-2

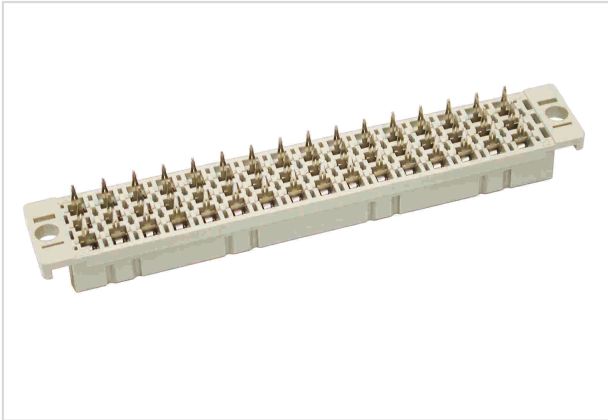


Image is for illustration purposes only. Please refer to product description.

Part number	09 06 232 6832
Specification	DIN-Power Flow032FP-4,5C1-2
HARTING eCatalogue	https://b2b.harting.com/09062326832

Identification

Category	Connectors
Series	DIN 41612
Identification	Type F
Element	Female connector
Description of the contact	Straight
Features	lead-free

Version

Termination method	Press-in termination
Connection type	Motherboard to daughtercard Mezzanine
Number of contacts	32
Contact configuration	Rows z and b, positions 2, 4, ... , 30, 32
Termination length	4.5 mm
Coding	Hole coding Coding with loss of contacts Shroud coding
PCB fixing	With fixing flange

Technical characteristics

Contact rows	3
Contact spacing (termination side)	3.81 mm 5.08 mm
Contact spacing (mating side)	3.81 mm 5.08 mm



Pushing Performance

Technical characteristics

Rated current	6 A
Rated current	Rated current measured at 20 °C, see derating curve for details
Clearance distance	≥1.6 mm
Creepage distance	≥3 mm
Insulation resistance	>10 ¹² Ω
Contact resistance	≤15 mΩ
Limiting temperature	-40 ... +105 °C upper limiting temperature limited by the pcb
Insertion and withdrawal force	≤50 N
Performance level	2 acc. to IEC 60603-2
Mating cycles	≥400
Test voltage U _{r.m.s.}	1.55 kV (contact-contact)
Isolation group	IIIa (175 ≤ CTI < 400)
PCB thickness	≥1.6 mm
Hot plugging	No

Material properties

Material (insert)	Thermoplastic resin, glass-fibre filled
Colour (insert)	RAL 7032 (pebble grey)
Material (contacts)	Copper alloy
Surface (contacts)	Noble metal over Ni Mating side Ni Termination side
Material flammability class acc. to UL 94	V-0
RoHS	compliant
ELV status	compliant
China RoHS	e
REACH Annex XVII substances	Not contained
REACH ANNEX XIV substances	Not contained
REACH SVHC substances	Not contained
California Proposition 65 substances	Yes
California Proposition 65 substances	Antimony trioxide

Specifications and approvals

Specifications	IEC 60603-2
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Pushing Performance

Specifications and approvals

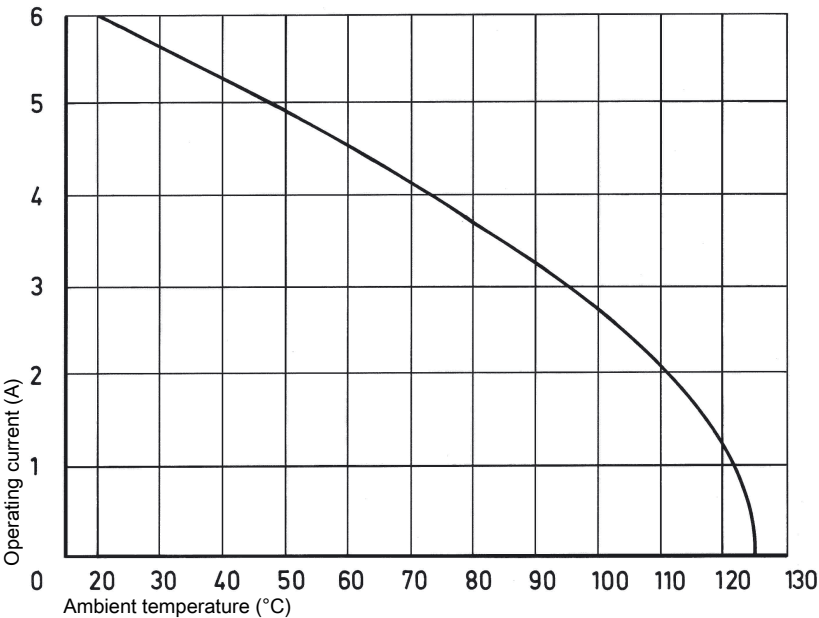
UL / CSA	UL 1977 ECBT2.E102079 CSA-C22.2 No. 182.3 ECBT8.E102079
Railway classification	F4/I3 acc. to NFF 16-101/102

Commercial data

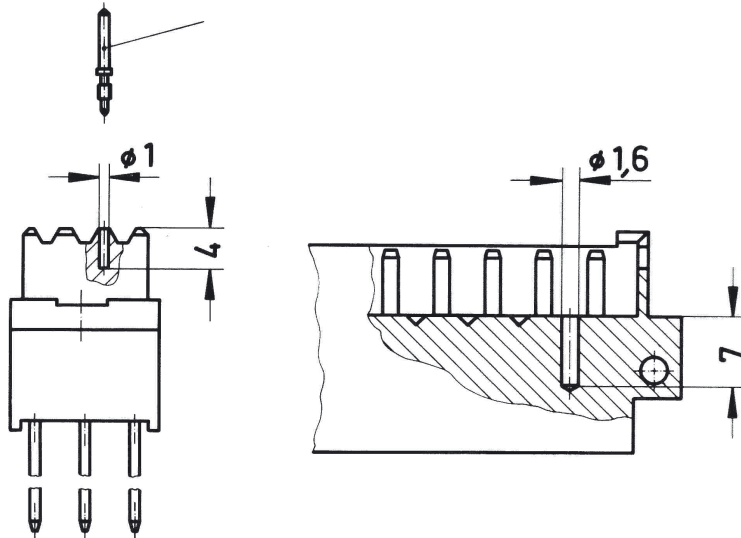
Packaging size	20
Net weight	12.72 g
Country of origin	Romania
European customs tariff number	85366990
eCl@ss	27460201 PCB connector (board connector)

Current carrying capacity

The current carrying capacity of the connectors is limited by the thermal load capability of the contact element material including the connections and the insulating parts. The derating curve is therefore valid for currents which flow constantly (non-intermittent) through each contact element of the connector evenly, without exceeding the allowed maximum temperature.
Measuring and testing techniques acc. to IEC 60512-5-2

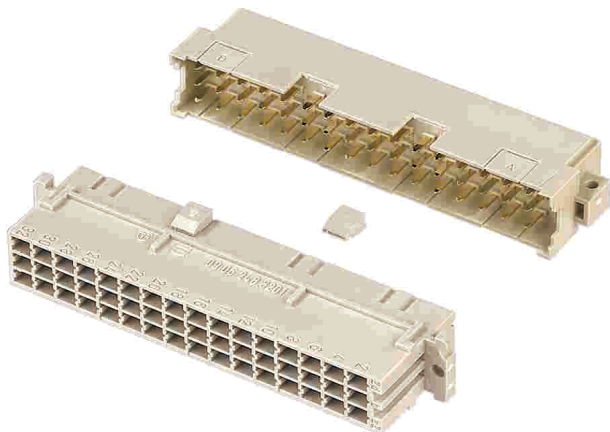


Hole coding (without loss of contact)



To avoid cross-plugging of adjacent connectors a coding system is required. With the aid of the marked indents between the contact rows of the male connector a hole has to be drilled at the desired position (also see drawing). The code pin can then be inserted into the corresponding cavity of the female connector by the means of the insertion tool.

Shroud coding (without loss of contact)



To avoid cross-plugging of adjacent connectors a coding system is required. Insert the code key 09 06 001 9919 into one of the keyways of the female connector as shown in the drawing. Break out the corresponding area of the male shroud. Connectors coded this way can only be applied in a minimum rack spacing of 20.32 mm.

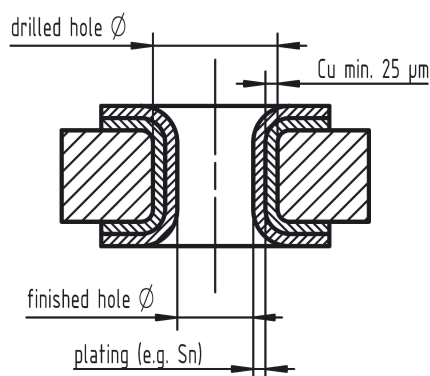
Coding with loss of contacts

To avoid cross-plugging of adjacent connectors a coding system is required.

Coding pin 09 04 000 9908

Removal tool for male contacts 09 99 000 0038

Recommended configuration of plated through holes



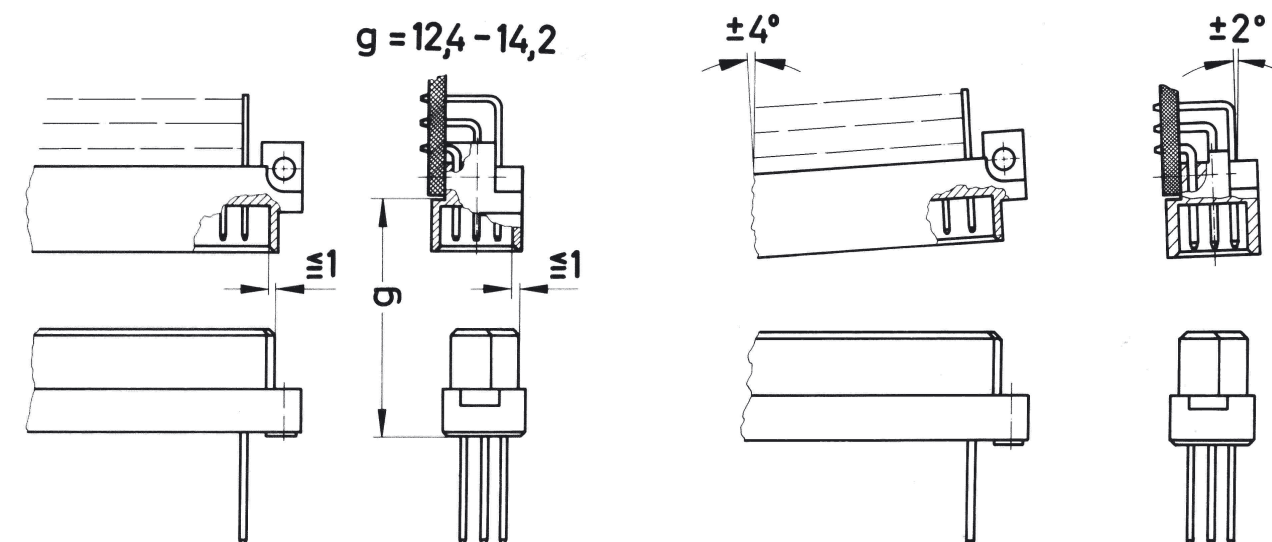
Tin plated PCB (HAL) acc. to EN 60352-5	Drilled hole Ø	1,15±0,025 mm
	Sn	max. 15 µm
	plated hole Ø	0,94 - 1,09 mm
Chemical tin plated PCB	Drilled hole Ø	1,15±0,025 mm
	Sn	min. 0,8µm
	plated hole Ø	1,00 - 1,10 mm
Gold /Nickel plated PCB	Drilled hole Ø	1,15±0,025 mm
	Ni	3 - 7 µm
	Au	0,05 - 0,12 µm
	plated hole Ø	1,00 - 1,10 mm
Silver plated PCB	Drilled hole Ø	1,15±0,025 mm
	Ag	0,1 - 0,3 µm
	plated hole Ø	1,00 - 1,10 mm
Copper plated PCB (OSP)	Drilled hole Ø	1,15±0,025 mm
	plated hole Ø	1,00 - 1,10 mm

In addition to the hot-air-level (HAL) other pcb surfaces are getting more important. Due to their different properties, such as mechanical strength and coefficient of friction we recommend the above mentioned configuration of pcb through holes.

Assembly instructions

It is highly recommended to use HARTING press-in tools to ensure a reliable press-in process. Please refer to the catalogue for tools, machines and further information for the press-in process.

Mating conditions



To ensure reliable connections and prevent unnecessary damage, please refer to the application data diagrams. These recommendations are set out in IEC 60603-2. The connectors should not be coupled and decoupled under electrical load.